

Irish Standard I.S. EN 60603-7-2:2010

Connectors for electronic equipment --Part 7-2: Detail specification for 8-way, unshielded, free and fixed connectors, for data transmissions with frequencies up to 100 MHz (IEC 60603-7-2:2010 (EQV))

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EUROPEAN STANDARD

EN 60603-7-2

NORME EUROPÉENNE EUROPÄISCHE NORM

July 2010

ICS 31.220.10

Supersedes EN 60603-7-2:2009

English version

Connectors for electronic equipment Part 7-2: Detail specification for 8-way, unshielded, free and fixed connectors, for data transmissions with frequencies up to 100 MHz (IEC 60603-7-2:2010)

Connecteurs pour équipements électroniques -Partie 7-2: Spécification particulière pour les fiches et les embases non blindées à 8 voies pour la transmission de données à des fréquences jusqu'à 100 MHz (CEI 60603-7-2:2010) Steckverbinder für elektronische Einrichtungen -Teil 7-2: Bauartspezifikation für ungeschirmte freie und feste Steckverbinder, 8polig, für Datenübertragungen bis 100 MHz (IEC 60603-7-2:2010)

This European Standard was approved by CENELEC on 2010-07-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Croatia, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Portugal, Romania, Slovakia, Slovenia, Spain, Sweden, Switzerland and the United Kingdom.

CENELEC

European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung

Management Centre: Avenue Marnix 17, B - 1000 Brussels

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Foreword

The text of document 48B/2135/FDIS, future edition 2 of IEC 60603-7-2, prepared by SC 48B, Connectors, of IEC TC 48, Electromechanical components and mechanical structures for electronic equipment, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 60603-7-2 on 2010-07-01.

This European Standard supersedes EN 60603-7-2:2009.

The main technical changes with regard to EN 60603-7-2:2009 are as follows:

- Removal of test methods that are now referenced to EN 60512-27-100.
- Addition of TCL and TCTL requirements.
- Removal of the electrical, mechanical, dimensional, environmental conditioning tests by reference to EN 60603-7.

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CEN and CENELEC shall not be held responsible for identifying any or all such patent rights.

The following dates were fixed:

 latest date by which the EN has to be implemented at national level by publication of an identical national standard or by endorsement

(dop) 2011-04-01

 latest date by which the national standards conflicting with the EN have to be withdrawn

(dow) 2013-07-01

Annex ZA has been added by CENELEC.

Endorsement notice

The text of the International Standard IEC 60603-7-2:2010 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following note has to be added for the standard indicated:

IEC 60512-26-100:2008 NOTE Harmonized as EN 60512-26-100:2008 (not modified).

EN 60603-7-2:2010

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	EN/HD	<u>Year</u>
IEC 60512-1-100	-	Connectors for electronic equipment - Tests and measurements - Part 1-100: General - Applicable publications	EN 60512-1-100	-
IEC 60512-2-1	-	Connectors for electronic equipment - Tests and measurements - Part 2-1: Electrical continuity and contact resistance tests - Test 2a: Contact resistance - Millivolt level method	EN 60512-2-1	-
IEC 60512-27-100	1)	Connectors for electronic equipment - Tests and measurements - Part 27-100: Signal integrity tests up to 500 MHz on IEC 60603-7 series connectors - Tests 27a to 27g	EN 60512-27-100	1)
IEC 60603-7	2008	Connectors for electronic equipment - Part 7: Detail specification for 8-way, unshielded, free and fixed connectors	EN 60603-7	2009
IEC 61156	Series	Multicore and symmetrical pair/quad cables for digital communications	-	-
IEC 62153-4-12	2009	Metallic communication cable test methods - Part 4-12: Electromagnetic compatibility (EMC) - Coupling attenuation or screening attenuation of connecting hardware - Absorbing clamp method	-	-

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¹⁾ To be published.

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

CONNECTORS FOR ELECTRONIC EQUIPMENT -

Part 7-2: Detail specification for 8-way, unshielded, free and fixed connectors, for data transmissions with frequencies up to 100 MHz

FOREWORD

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International Standard IEC 60603-7-2 has been prepared by subcommittee 48B: Connectors, of IEC technical committee 48: Electromechanical components and mechanical structures for electronic equipment.

This second edition of IEC 60603-7-2 cancels and replaces the first edition issued in 2007, and constitutes a technical revision.

The main technical changes with regard to the previous edition are as follows:

- Removal of test methods that are now referenced to IEC 60512-27-100.
- Addition of TCL and TCTL requirements.
- Removal of the electrical, mechanical, dimensional, environmental conditioning tests by reference to IEC 60603-7.

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The text of this standard is based on the following documents:

FDIS	Report on voting
48B/2135/FDIS	48B/2176/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of IEC 60603 series, under the general title *Connectors for electronic equipment*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

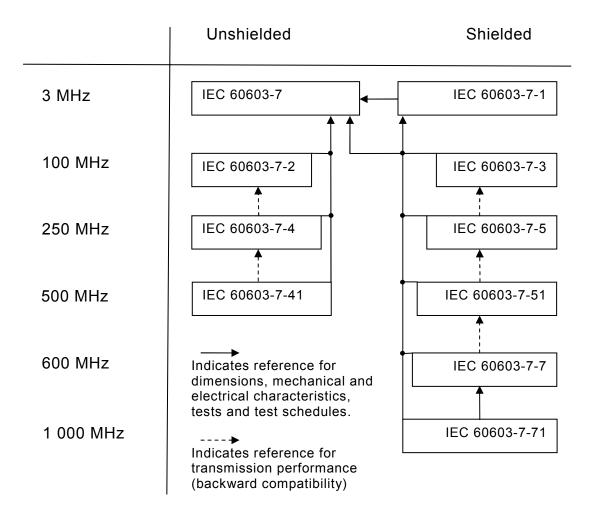
- · reconfirmed.
- · withdrawn,
- · replaced by a revised edition, or
- amended.

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INTRODUCTION

IEC 60603-7 is the base specification of the whole series. Subsequent specifications do not duplicate information given in the base document, but list only additional requirements. For complete specification regarding a component of a higher number document all lower numbered documents shall be considered as well. The following diagram shows the interrelation of the documents:





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